PC815 Series

High Sensitivity, High Density Mounting Type Photocoupler

❋ Lead forming type （I type ）and taping reel type （P type ）are also available.（**PC815I/PC815P** ）
❋❋ TÜV （VDE0884 ）approved type is also available as an option.

■ Features

1. High current transfer ratio
（CTR: MIN. 600% at I_F= 1mA, V_{CE} = 2V）
2. High isolation voltage between input and output
（V_{iso} : 5 000V $_{rms}$）
3. Compact dual-in-line package
PC815 : 1-channel type **PC825** : 2-channel type
PC835 : 3-channel type **PC845** : 4-channel type
4. Recognized by UL file No. E64380

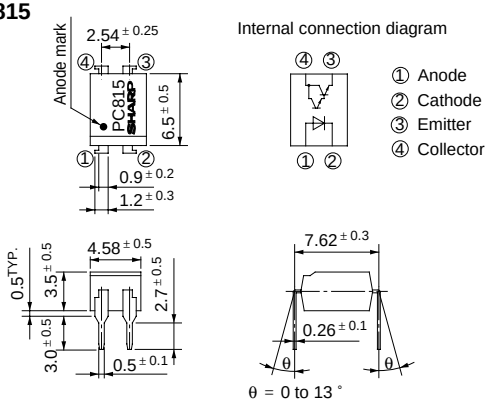
■ Applications

1. System appliances, measuring instruments
2. Industrial robots
3. Copiers, automatic vending machines
4. Signal transmission between circuits of different potentials and impedances

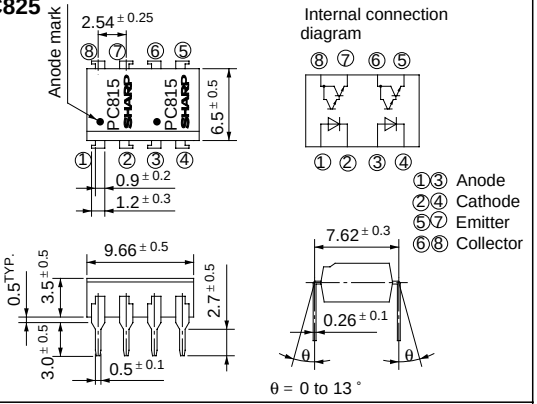
■ Outline Dimensions

（Unit : mm ）

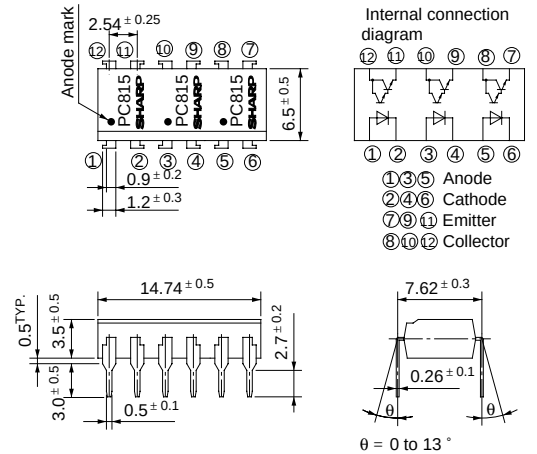
PC815



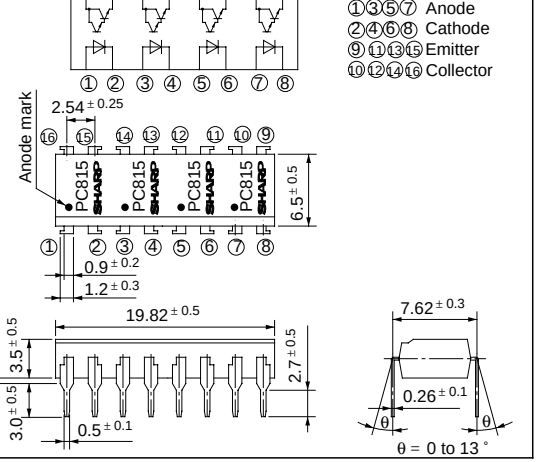
PC825



PC835



PC845



■ Absolute Maximum Ratings

(Ta= 25˚C)

Parameter		Symbol	Rating	Unit
Input	Forward current	I_F	50	mA
	*1 Peak forward current	I_{FM}	1	A
	Reverse voltage	V_R	6	V
	Power dissipation	P	70	mW
Output	Collector-emitter voltage	V_{CEO}	35	V
	Emitter-collector voltage	V_{ECO}	6	V
	Collector current	I_C	80	mA
	Collector power dissipation	P_C	150	mW
Total power dissipation		P_{tot}	200	mW
*2 Isolation voltage		V_{iso}	5 000	V_{rms}
Operating temperature		T_{opr}	- 30 to + 100	˚C
Storage temperature		T_{stg}	- 55 to + 125	˚C
*3 Soldering temperature		T_{sol}	260	˚C

*1 Pulse width<=100 μ s, Duty ratio : 0.001
*2 40 to 60% RH, AC for 1 minute
*3 For 10 seconds

■ Electro-optical Characteristics

(Ta= 25˚C)

Parameter			Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage		V_F	I_F = 20mA	-	1.2	1.4	V
	Peak forward voltage		V_{FM}	I_{FM} = 0.5A	-	-	3.0	V
	Reverse current		I_R	V_R = 4V	-	-	10	μ A
	Terminal capacitance		C_t	V= 0, f= 1kHz	-	30	250	pF
Output	Collector dark current		I_{CEO}	V_{CE} = 10V, I_F = 0	-	-	10^{-6}	A
Transfer characteristics	Current transfer ratio		CTR	I_F = 1mA, V_{CE} = 2V	600	-	7 500	%
	Collector-emitter saturation voltage		$V_{CE(sat)}$	I_F = 20mA, I_C = 5mA	-	0.8	1.0	V
	Isolation resistance		R_{ISO}	DC500V, 40 to 60% RH	5×10^{10}	10^{11}	-	Ω
	Floating capacitance		C_f	V= 0, f= 1MHz	-	0.6	1.0	pF
	Cut-off frequency		f_c	V_{CE} = 2V, I_C = 2mA, R_L = 100Ω	1	6	-	kHz
	Response time	Rise time	t_r	V_{CE} = 2V, I_C = 10mA, R_L = 100Ω	-	60	300	μ s
		Fall time	t_f		-	53	250	μ s

Fig. 1 Forward Current vs. Ambient Temperature

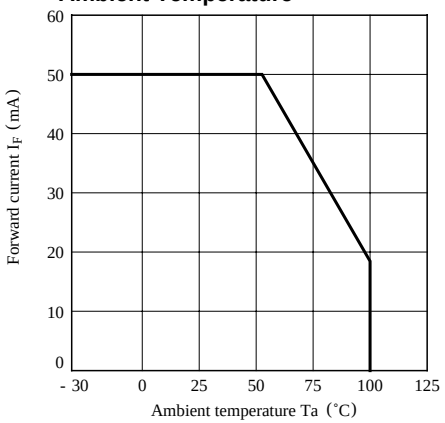


Fig. 2 Collector Power Dissipation vs. Ambient Temperature

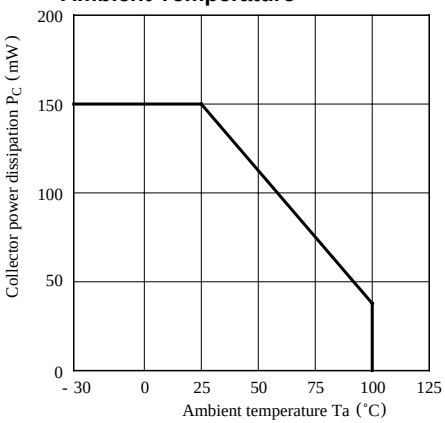


Fig. 3 Peak Forward Current vs. Duty Ratio

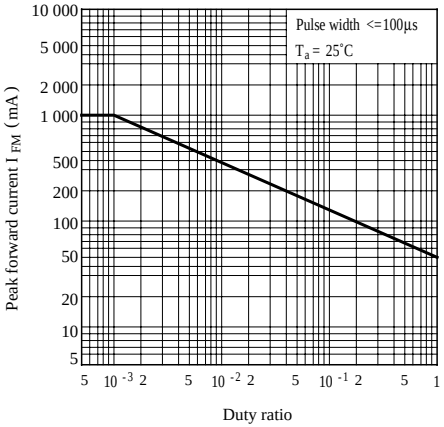


Fig. 4 Forward Current vs. Forward Voltage

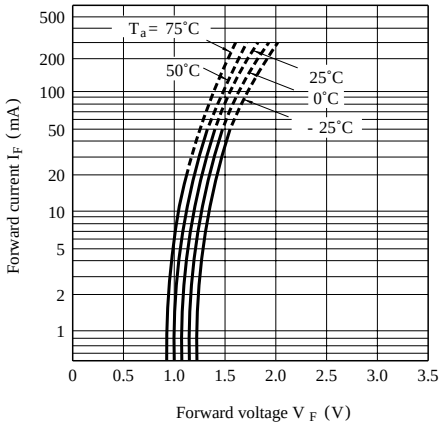


Fig. 5 Current Transfer Ratio vs. Forward Current

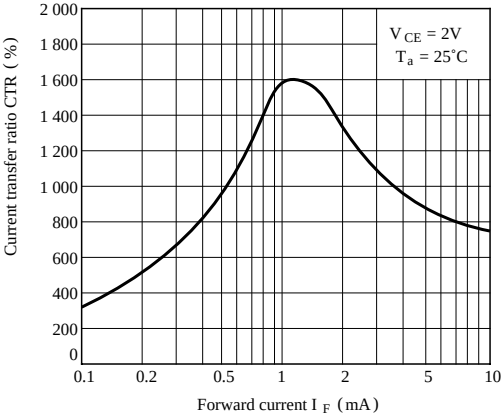


Fig. 6 Collector Current vs. Collector-emitter Voltage

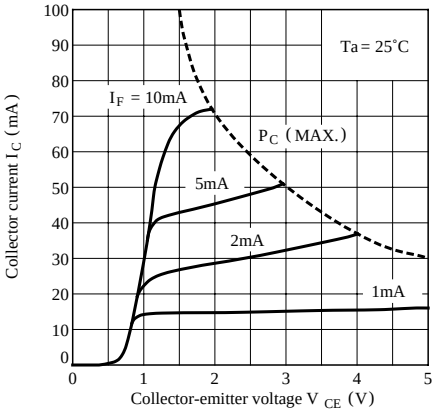


Fig. 7 Relative Current Transfer Ratio vs. Ambient Temperature

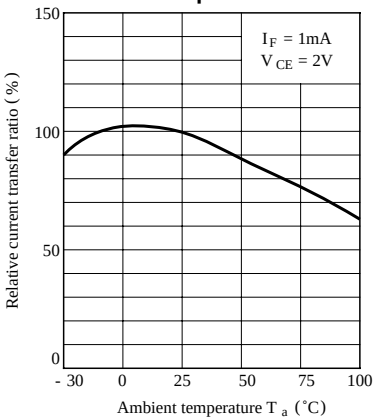


Fig. 8 Collector-emitter Saturation Voltage vs. Ambient Temperature

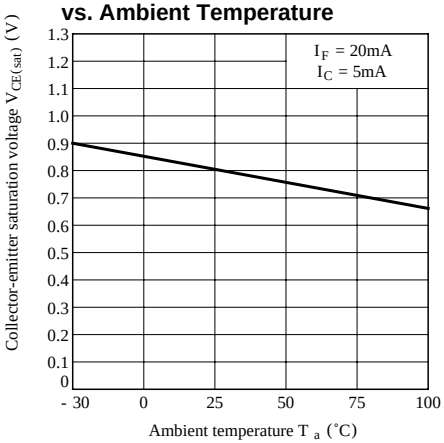


Fig. 9 Collector Dark Current vs. Ambient Temperature

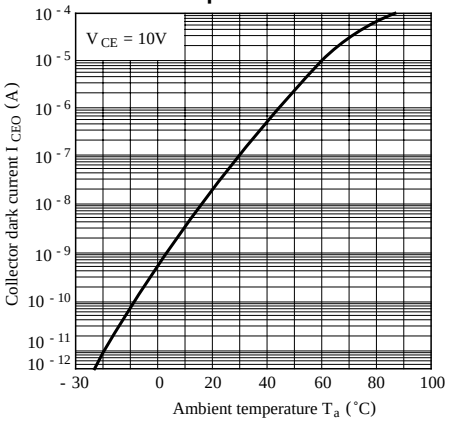


Fig.10 Response Time vs. Load Resistance

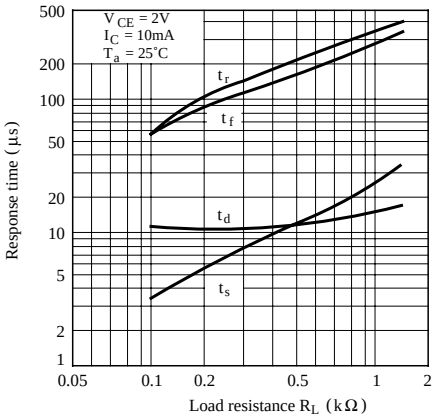
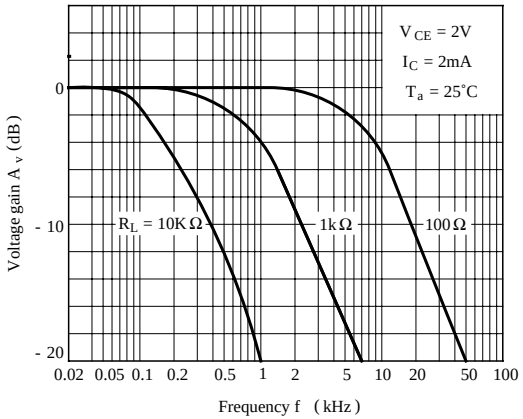


Fig.11 Frequency Response



Test Circuit for Response Time

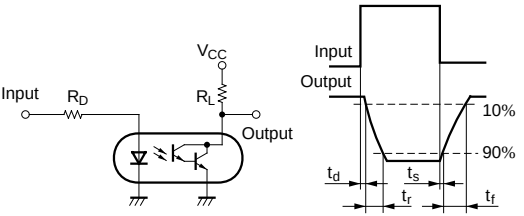
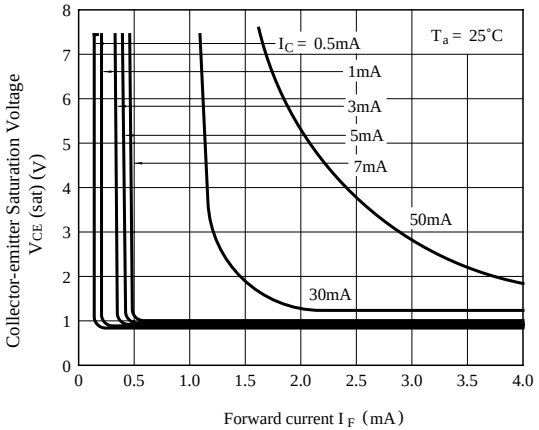
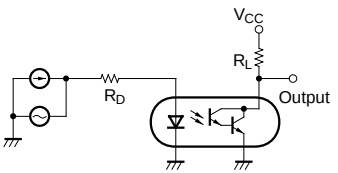


Fig.12 Collector-emitter Saturation Voltage vs. Forward Current



Test Circuit for Frepuency Response



● Please refer to the chapter "Precautions for Use"

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